IGBT - Field Stop 600 V, 20 A

FGH20N60SFDTU, FGH20N60SFDTU-F085

Description

Using Novel Field Stop IGBT Technology, ON Semiconductor's new series of Field Stop IGBTs offer the optimum performance for Automotive Chargers, Inverter, and other applications where low conduction and switching losses are essential.

Features

- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 2.2 \text{ V} @ I_C = 20 \text{ A}$
- High Input Impedance
- Fast Switching
- Qualified to Automotive Requirements of AEC-Q101 (FGH20N60SFDTU-F085)
- These Devices are Pb-Free and are RoHS Compliant

Applications

- Automotive Chargers, Converters, High Voltage Auxiliaries
- Inverters, PFC, UPS



ON Semiconductor®

www.onsemi.com





TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ABSOLUTE MAXIMUM RATINGS

Description	Symbol	Ratings	Unit	
Collector to Emitter Voltage	V _{CES}	600	V	
Gate to Emitter Voltage	V _{GES}	±20	V	
Transient Gate-to-Emitter Voltage		±30	V	
Collector Current Tc = 25°C		Ι _C	40	А
Tc = 100°C			20	А
Pulsed Collector Current	I _{CM} (Note 1)	60	А	
Maximum Power Dissipation Tc = 25°C		PD	165	W
		66	W	
Operating Junction Temperature	TJ	–55 to +150	°C	
Storage Temperature Range	T _{stg}	–55 to +150	°C	
Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Sec	TL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance Junction-to-Case	$R_{\theta JC}$ (IGBT)	0.76	°C/W
Thermal Resistance Junction-to-Case	$R_{ hetaJC}$ (Diode)	2.51	°C/W
Thermal Resistance Junction-to-Ambient	$R_{ hetaJA}$	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Package Method	Reel Size	Tape Width	Quantity
FGH20N60SFDTU	FGH20N60SFD	TO-247	Tube	-	-	30
FGH20N60SFDTU-F085*	FGH20N60SFDTU	TO-247	Tube	-	-	30

*Qualified to Automotive Requirements of AEC-Q101

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS	-			-		
Collector to Emitter Breakdown Voltage	BV _{CES}	V_{GE} = 0 V, I_C = 250 μ A	600	-	-	V
Temperature Coefficient of Breakdown Voltage	$\Delta BV_{CES} / \Delta T_{J}$	V_{GE} = 0 V, I _C = 250 µA	-	0.6	_	V/°C
Collector Cut-Off Current	I _{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
G-E Leakage Current	I _{GES}	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTERISTICs	•	•			•	
G-E Threshold Voltage	V _{GE(th)}	$I_C = 250 \ \mu A, \ V_{CE} = V_{GE}$	4.0	4.6	6.5	V
Collector to Emitter Saturation Voltage	V _{CE(sat)}	I _C = 20 A, V _{GE} = 15 V	-	2.2	2.8	V
		I_{C} = 20 A, V_{GE} = 15 V, T_{C} = 125°C	-	2.4	-	V
DYNAMIC CHARACTERISTICS	-			-		
Input Capacitance	Cies	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	-	985	-	pF
Output Capacitance	C _{oes}	1	-	110	-	pF
Reverse Transfer Capacitance	C _{res}	1	-	40	-	pF

ELECTRICAL CHARACTERISTICS OF THE IGBT ($T_C = 25^{\circ}C$ unless otherwise noted) (continued)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS			-			-
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 20 \text{ A},$	-	13	-	ns
Rise Time	t _r	$R_G = 10 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	_	18	-	ns
Turn-Off Delay Time	t _{d(off)}	7	_	90	-	ns
Fall Time	t _f	7	-	20	48	ns
Turn-On Switching Loss	E _{on}	7	-	0.43	-	mJ
Turn-Off Switching Loss	E _{off}		-	0.13	-	mJ
Total Switching Loss	E _{ts}		_	0.56	-	mJ
Turn-On Delay Time	t _{d(on)}	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 20 \text{ A}, \\ R_{G} = 10 \Omega, \text{ V}_{GE} = 15 \text{ V}, \\ \text{Inductive Load, } T_{C} = 125^{\circ}\text{C}$	-	13	-	ns
Rise Time	t _r		_	16	-	ns
Turn-Off Delay Time	t _{d(off)}		_	95	-	ns
Fall Time	t _f	7	_	50	-	ns
Turn-On Switching Loss	E _{on}	7	-	0.53	-	mJ
Turn–Off Switching Loss	E _{off}		-	0.24	-	mJ
Total Switching Loss	E _{ts}		-	0.77	-	mJ
Total Gate Charge	Qg	V_{CE} = 400 V, I _C = 20 A, V _{GE} = 15 V	-	66	-	nC
Gate to Emitter Charge	Q _{ge}	1	-	7	-	nC
Gate to Collector Charge	Q _{gc}	1	_	33	-	nC

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_J = 25° C unless otherwise noted)

Parametr	Symbol	Test Conditions		Min	Тур	Max	Unit
Diode Forward Voltage	V _{FM}	I _F = 10 A	T _C = 25°C	-	1.9	2.5	V
			T _C = 125°C	-	1.7	-	
Diode Reverse Recovery Time	t _{rr}	I_F = 10 A, di _F /dt = 200 A/µs	T _C = 25°C	-	40	-	ns
			T _C = 125°C	-	180	-	
Diode Reverse Recovery Charge	Q _{rr}		$T_{C} = 25^{\circ}C$	-	70	-	nC
			T _C = 125°C	_	495	_	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS



Figure 1. Typical Output Characteristics



Figure 3. Typical Saturation Voltage Characteristics



Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level



Figure 2. Typical Output Characteristics





Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (continued)



Figure 7. Saturation Voltage vs. V_{GE}



Figure 9. Capacitance Characteristics





Figure 8. Saturation Voltage vs. V_{GE}



Figure 10. Gate Charge Characteristics



TYPICAL PERFORMANCE CHARACTERISTICS (continued)







Figure 15. Turn-off Characteristics vs. Collector Current





Figure 14. Turn-on Characteristics vs. Collector Current



Figure 16. Switching Loss vs. Gate Resistance



TYPICAL PERFORMANCE CHARACTERISTICS (continued)



Figure 23. Transient Thermal Impedance of IGBT





ON Semiconductor and use trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>